#### Lampiran 1 Daftar Riwayat Hidup



#### PERSONAL PROFILE

My name is Muhammad Fatoni. I was born in Pandeglang May 5, 1999. Working as a physical security engineering in enterprise scale Data Center & responsible for physical security in terms of data center.

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#### EDUCATIONAL HISTORY

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#### WORK EXPERIENCEWORK

#### **PT Telkom Akses**

FEBRUARY 2017 - AUGUST 2017

#### Work as a maintenance engineer

- Install internet for customers
- Responsible for maintaining both wired and wireless optical networks in the Pandeglang district area
- Provide the best service for customers

#### PT Putradabo Perkasa

AGUST2017 - NOVEMBER 2018

#### Work as a physical security Engineer

- Develop solutions and technologies that will meet the needs and business objectives in various fields of Physical Security and Network Installation
- Responsible for maintaining CCTV network equipment, access control and visitor access management

#### PT Sigma cipta caraka (Telkomsigma)

NOVEMBER 2018 - NOW

#### Work as a physical security Engineer

- Manage day to day operation data center floor management unit to achieve SLA standard with customer & Fullfil SLA within standard & procedure
- Management & Maintenance of physical security
- Be responsible for monthly reports on physical safety and recommend treatment results that are not in accordance with normal conditions and analyze monitoring results that are not in accordance with normal conditions
- Monitoring data center devices and physical security devices

#### **Lampiran 2 Source Code**

```
#include <Arduino.h>
#include <ArduinoJson.h>
#include <FS.h>
#include "DHT.h"
#include <DHT_U.h>
#include <BlynkSimpleEsp8266.h>
#include <WiFiManager.h>
#define DHTTYPE DHT11
#define RELAY D5
#define LED_A D8
#define LED_B D7
#define AUTH ""
#define WIFI_SSID "rumahkucing"
#define WIFI_PASS "1sl4m4g4m4ku"
DHT dht(D2, DHTTYPE);
DHT dht2(D3, DHTTYPE);
DHT dht3(D4, DHTTYPE);
DHT dht4(D6, DHTTYPE);
DHT dhts[4] = \{dht, dht2, dht3, dht4\};
struct WirelessSettings{
 const char* AP_SSID = "Healthy Monitor";
 const char* AP_PASS = "12345678";
```

```
char blynkToken[65];
 bool saveConfigState = false;
 String blynkTokenStr;
}connection;
void connectBlynk();
String ipToString(IPAddress ipA);
void callback(WiFiManager *myWiFiManager);
void saveConfigCallback();
void writeFile(const char* path, const char *data);
String readFromFile(const char* path, const char* data);
void saveBlynkToken(const char *paramValue);
unsigned long tick;
BLYNK_WRITE(V13){
 if(param.asInt() == 1){
  digitalWrite(LED_A, HIGH);
  digitalWrite(LED_B, HIGH);
  Serial.print("AP Mode: ");
  Serial.println(param.asInt());
  // WiFi.disconnect();
  Blynk.disconnect();
  WiFiManagerParameter customParam("token", "Blynk Token",
connection.blynkToken, 50);
  WiFiManager wm;
  wm.setDebugOutput(false);
```

```
wm.setAPCallback(&callback);
  wm.setSaveConfigCallback(saveConfigCallback);
  wm.addParameter(&customParam);
  // WiFi.mode(WIFI_AP);
  if(wm.startConfigPortal(connection.AP_SSID, connection.AP_PASS)){
   Serial.print("SSID: ");
   Serial.println(WiFi.SSID());
   Serial.print("IP: ");
   Serial.println(WiFi.localIP());
   saveBlynkToken(customParam.getValue());
  Serial.println("Press Reset Button to Aplly Change");
  Blynk.config(connection.blynkTokenStr.c_str(), "iot.serangkota.go.id", 8080);
  while(Blynk.connect() != true) { }
  Serial.println("Connected To Blynk");
  Blynk.virtualWrite(V14, WiFi.SSID());
  Blynk.virtualWrite(V15, ipToString(WiFi.localIP()));
  digitalWrite(LED_A, LOW);
void setup() {
 Serial.begin(115200);
 pinMode(LED_A, OUTPUT);
 pinMode(LED_B, OUTPUT);
 pinMode(RELAY, OUTPUT);
 if(SPIFFS.begin()){
```

```
if(!SPIFFS.exists("/config.json")){
   File file = SPIFFS.open("/config.json", "w");
   StaticJsonDocument<250> doc;
   doc["blynk_token"] = "";
   serializeJson(doc, file);
 }
 dht.begin();
 dht2.begin();
 dht3.begin();
 dht4.begin();
 connectBlynk();
}
void loop() {
 if(!Blynk.connected()){
  connectBlynk();
 Blynk.run();
 if(millis() - tick > 2000) \{ tick \}
  = millis();
  digitalWrite(LED_B, HIGH);
  delay(50);
  digitalWrite(LED_B, LOW);
  delay(50);
  digitalWrite(LED_B, HIGH);
```

```
delay(50); digitalWrite(LED_B,
LOW); float h =
dht.readHumidity(); float t =
dht.readTemperature();
float h2 = dht2.readHumidity();
float t2 = dht2.readTemperature();
float h3 = dht3.readHumidity();
float t3 = dht3.readTemperature();
float h4 = dht4.readHumidity();
float t4 = dht4.readTemperature();
// Check if any reads failed and exit early (to try again).
if (isnan(h) || isnan(t)) {
 Serial.println(F("Failed to read from DHT sensor!"));
 return;
if (isnan(h2) || isnan(t2)) {
 Serial.println(F("Failed to read from DHT2 sensor!"));
 return;
if (isnan(h3) || isnan(t3)) {
 Serial.println(F("Failed to read from DHT3 sensor!"));
 return;
if (isnan(h4) || isnan(t4)) {
```

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```
Serial.println(F("Failed to read from DHT4 sensor!"));
 return;
Blynk.virtualWrite(V0,
                           t);
Blynk.virtualWrite(V1, h);
Blynk.virtualWrite(V2, t2);
Blynk.virtualWrite(V3, h2);
Blynk.virtualWrite(V4, t3);
Blynk.virtualWrite(V5, h3);
Blynk.virtualWrite(V6, t4);
Blynk.virtualWrite(V7, h4);
Serial.print("H: ");
Serial.print(h);
Serial.print("\tT: ");
Serial.print(t);
Serial.print(" | H2: ");
Serial.print(h2);
Serial.print("\tT2: ");
Serial.print(t2);
Serial.print(" | H3: ");
Serial.print(h3);
Serial.print("\tT3: ");
Serial.print(t3);
```

```
Serial.print(" | H4: ");
  Serial.print(h4);
  Serial.print("\tT4: ");
  Serial.println(t4);
void connectBlynk(){
 digitalWrite(LED_A, HIGH);
 digitalWrite(LED_B, LOW);
 WiFiManagerParameter customParam("token", "Blynk Token",
connection.blynkToken, 50);
 WiFiManager wm; wm.setDebugOutput(false);
 wm.setAPCallback(&callback);
 wm.setSaveConfigCallback(saveConfigCallback);
 wm.addParameter(&customParam);
 if(wm.autoConnect(connection.AP_SSID, connection.AP_PASS)){
  Serial.print("SSID: ");
  Serial.println(WiFi.SSID());
  Serial.print("IP: ");
  Serial.println(WiFi.localIP());
  saveBlynkToken(customParam.getValue());
 Serial.println("Connecting to Blynk...");
 Blynk.config(connection.blynkTokenStr.c_str(), "iot.serangkota.go.id", 8080);
 while(Blynk.connect() != true) { }
```

```
Serial.println("Connected To Blynk");
 Blynk.virtualWrite(V14, WiFi.SSID());
 Blynk.virtualWrite(V15, ipToString(WiFi.localIP()));
 digitalWrite(LED_A, LOW);
}
String ipToString(IPAddress ipA){
 String s="";
 for (int i=0; i<4; i++)
  s += i ? "." + String(ipA[i]) : String(ipA[i]);
 return s;
}
void callback(WiFiManager *myWiFiManager){
 digitalWrite(LED_A, HIGH);
 digitalWrite(LED_B, HIGH);
 Serial.println("Starting AP...\n");
void saveConfigCallback(){
 connection.saveConfigState = true;
}
void writeFile(const char* path, const char* data){
 delay(1000);
 File file = SPIFFS.open(path, "w");
 StaticJsonDocument<250> doc;
 doc["blynk_token"] = data;
```

```
if(serializeJson(doc, file) == 0){
  // Serial.println("Failed to write file!");
 else{
  Serial.println("Success to write file\n");
 file.close();
}
String readFromFile(const char* path, const char* data){
 String value;
 File file = SPIFFS.open(path, "r");
 if(file){
  StaticJsonDocument<250> doc;
  deserializeJson(doc,file);
  String temp = doc[data].as<String>();
  value = temp;
 file.close();
 return value;
}
void saveBlynkToken(const char *paramValue){
 if(connection.saveConfigState){
 strcpy(connection.blynkToken, paramValue);
  writeFile("/config.json", connection.blynkToken);
 if(SPIFFS.exists("/config.json")){
```

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```
connection.blynkTokenStr = readFromFile("/config.json", "blynk_token");
Serial.print("Blynk Token: ");
Serial.println(connection.blynkTokenStr);
connection.saveConfigState = false;
}
}
```

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Lampiran 2 Data Sheet NODEMCU ESP8266

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ESP8266EX

**Datasheet** 





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## **About This Guide**

This document introduces the specifications of ESP8266EX.

#### Release Notes

Date	Version	Release Notes			
2015.12	V4.6	Updated Chapter 3.			
2016.02	V4.7	Updated Section 3.6 and Section 4.1.			
2016.04	V4.8	Updated Chapter 1.			
2016.08	V4.9	Updated Chapter 1.			
2016.11	V5.0	Added Appendix II "Learning Resources".			
2016.11	V5.1	Changed the power consumption during Deep-sleep from 10 $\mu\text{A}$ to 20 $\mu\text{A}$ in Table 5-2.			
2016.11	V5.2	Changed the crystal frequency range from "26 MHz to 52 MHz" to "24 MHz to 52 MHz" in Section 3.3.			
2016.12	V5.3	Changed the minimum working voltage from 3.0 V to 2.5 V.			
2017.04	V5.4	Changed chip input and output impedance from 50 $\Omega$ to 39 + j6 $\Omega$ .			
2017.10	V5.5	Updated Chapter 3 regarding the range of clock amplitude to 0.8 V $\sim$ 1.5 V.			
2017.11	V5.6	Updated VDDPST from 1.8 V $\sim$ 3.3 V to 1.8 V $\sim$ 3.6 V.			
2017.11	V5.7	<ul> <li>Corrected a typo in the description of SDIO_DATA_0 in Table 2-1;</li> <li>Added the testing conditions for the data in Table 5-2.</li> </ul>			
2018.02	V5.8	<ul> <li>Updated Wi-Fi protocols in Section 1.1;</li> <li>Updated description of the integrated Tensilica processor in 3.1.</li> </ul>			

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Date	Version	Release Notes
2018.09	V5.9	Update document cover; Added a note for Table 1-1; Updated Wi-Fi key features in Section 1.1; Updated description of the Wi-Fi function in 3.5; Updated pin layout diagram; Fixed a typo in Table 2-1; Removed Section AHB and AHB module; Restructured Section Power Management; Fixed a typo in Section UART; Removed description of transmission angle in Section IR Remote Control; Other optimization (wording).
2018.11	V6.0	<ul><li>Added an SPI pin in Table 4-2;</li><li>Updated the diagram of packing information.</li></ul>
2019.08	V6.1	Removed description of the GPIO function in Section 4.1.
2019.08	V6.2	Updated notes on CHIP_EN in Section 5.1
2019.12	V6.3	Add feedback links.
2020.04	V6.4	<ul><li>Removed the description of "Antenna diversity";</li><li>Updated the feedback links.</li></ul>
2020.07	V6.5	Updated the description of HSPI in Section 4.3;     Updated links in Appendix.
2020.10	V6.6	Fixed a typo in Figure 2-1;     Updated the link of ESP8266 Pin List.

#### Documentation Change Notification

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1. Overview

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1. Overview

Espressif's ESP8266EX delivers highly integrated Wi-Fi SoC solution to meet users' continuous demands for efficient power usage, compact design and reliable performance in the Internet of Things industry.

With the complete and self-contained Wi-Fi networking capabilities, ESP8266EX can perform either as a standalone application or as the slave to a host MCU. When ESP8266EX hosts the application, it promptly boots up from the flash. The integrated high-speed cache helps to increase the system performance and optimize the system memory. Also, ESP8266EX can be applied to any microcontroller design as a Wi-Fi adaptor through SPI/SDIO or UART interfaces.

ESP8266EX integrates antenna switches, RF balun, power amplifier, low noise receive amplifier, filters and power management modules. The compact design minimizes the PCB size and requires minimal external circuitries.

Besides the Wi-Fi functionalities, ESP8266EX also integrates an enhanced version of Tensilica's L106 Diamond series 32-bit processor and on-chip SRAM. It can be interfaced with external sensors and other devices through the GPIOs. Software Development Kit (SDK) provides sample codes for various applications.

Espressif Systems' Smart Connectivity Platform (ESCP) enables sophisticated features including:

- Fast switch between sleep and wakeup mode for energy-efficient purpose;
- Adaptive radio biasing for low-power operation
- Advance signal processing
- Spur cancellation and RF co-existence mechanisms for common cellular, Bluetooth, DDR, LVDS, LCD interference mitigation

#### 1.1. Wi-Fi Key Features

- 802.11 b/g/n support
- 802.11 n support (2.4 GHz), up to 72.2 Mbps
- Defragmentation
- 2 x virtual Wi-Fi interface
- Automatic beacon monitoring (hardware TSF)
- Support Infrastructure BSS Station mode/SoftAP mode/Promiscuous mode

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1. Overview



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#### 1.2. Specifications

Table 1-1. Specifications

Categories	Items	Parameters			
	Certification	Wi-Fi Alliance			
	Protocols	802.11 b/g/n (HT20)			
	Frequency Range	2.4 GHz ~ 2.5 GHz (2400 MHz ~ 2483.5 MHz)			
		802.11 b: +20 dBm			
Wi-Fi	TX Power	802.11 g: +17 dBm			
VVI-ГI		802.11 n: +14 dBm			
		802.11 b: -91 dbm (11 Mbps)			
	Rx Sensitivity	802.11 g: -75 dbm (54 Mbps)			
		802.11 n: -72 dbm (MCS7)			
	Antenna	PCB Trace, External, IPEX Connector, Ceramic Chip			
	CPU	Tensilica L106 32-bit processor			
	Dariaharal Interface	UART/SDIO/SPI/I2C/I2S/IR Remote Control			
	Peripheral Interface	GPIO/ADC/PWM/LED Light & Button			
Hardware	Operating Voltage	2.5 V ~ 3.6 V			
Haroware	Operating Current	Average value: 80 mA			
	Operating Temperature Range	−40 °C ~ 125 °C			
	Package Size	QFN32-pin (5 mm x 5 mm)			
	External Interface	-			
	Wi-Fi Mode	Station/SoftAP/SoftAP+Station			
	Security	WPA/WPA2			
	Encryption	WEP/TKIP/AES			
Software	Firmware Upgrade	UART Download / OTA (via network)			
Conwaro	Software Development	Supports Cloud Server Development / Firmware and SDK for fast on-chip programming			
	Network Protocols	IPv4, TCP/UDP/HTTP			
	User Configuration	AT Instruction Set, Cloud Server, Android/iOS App			

Note:

The TX power can be configured based on the actual user scenarios.

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1. Overview



#### 1.3. Applications

- Home appliances
- Home automation
- Smart plugs and lights
- Industrial wireless control
- Baby monitors
- IP cameras
- Sensor networks
- Wearable electronics
- Wi-Fi location-aware devices
- Security ID tags
- Wi-Fi position system beacons

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2. Pin Definitions

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2.

### **Pin Definitions**

Figure 2-1 shows the pin layout for 32-pin QFN package.

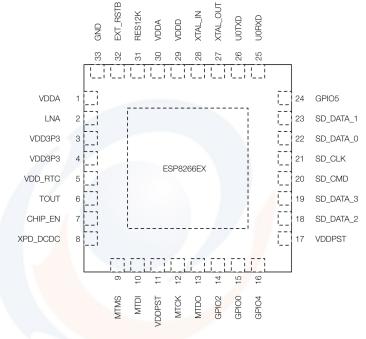


Figure 2-1. Pin Layout (Top View)

Table 2-1 lists the definitions and functions of each pin.

Table 2-1. ESP8266EX Pin Definitions

Pin	Name	Туре	Function
1	VDDA	Р	Analog Power 2.5 V ~ 3.6 V
2	LNA	I/O	RF antenna interface $ \text{Chip output impedance} = 39 + \text{j6 } \Omega. \text{ It is suggested to retain the $\pi$-type matching network to match the antenna.} $
3	VDD3P3	Р	Amplifier Power 2.5 V ~ 3.6 V

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Pin	Name	Туре	Function
4	VDD3P3	Р	Amplifier Power 2.5 V ~ 3.6 V
5	VDD_RTC	Р	NC (1.1 V)
6	TOUT	I	ADC pin. It can be used to test the power-supply voltage of VDD3P3 (Pin3 and Pin4) and the input power voltage of TOUT (Pin 6). However, these two functions cannot be used simultaneously.
7	CHIP_EN	I	Chip Enable High: On, chip works properly Low: Off, small current consumed
8	XPD_DCDC	I/O	Deep-sleep wakeup (need to be connected to EXT_RSTB); GPIO16
9	MTMS	I/O	GPIO 14; HSPI_CLK
10	MTDI	I/O	GPIO 12; HSPI_MISO
11	VDDPST	Р	Digital/IO Power Supply (1.8 V ~ 3.6 V)
12	MTCK	I/O	GPIO 13; HSPI_MOSI; UARTO_CTS
13	MTDO	I/O	GPIO 15; HSPI_CS; UARTO_RTS
14	GPIO2	I/O	UART TX during flash programming; GPIO2
15	GPI00	I/O	GPIO0; SPI_CS2
16	GPIO4	I/O	GPIO4
17	VDDPST	Р	Digital/IO Power Supply (1.8 V ~ 3.6 V)
18	SDIO_DATA_2	I/O	Connect to SD_D2 (Series R: 20 Ω); SPIHD; HSPIHD; GPIO9
19	SDIO_DATA_3	I/O	Connect to SD_D3 (Series R: 200 Ω); SPIWP; HSPIWP; GPIO10
20	SDIO_CMD	I/O	Connect to SD_CMD (Series R: 200 Ω); SPI_CS0; GPIO11
21	SDIO_CLK	I/O	Connect to SD_CLK (Series R: 200 Ω); SPI_CLK; GPIO6
22	SDIO_DATA_0	I/O	Connect to SD_D0 (Series R: 200 Ω); SPI_MISO; GPIO7
23	SDIO_DATA_1	I/O	Connect to SD_D1 (Series R: 200 Ω); SPI_MOSI; GPIO8
24	GPIO5	I/O	GPIO5
25	U0RXD	I/O	UART Rx during flash programming; GPIO3
26	U0TXD	I/O	UART TX during flash programming; GPIO1; SPI_CS1
27	XTAL_OUT	I/O	Connect to crystal oscillator output, can be used to provide BT clock input
28	XTAL_IN	I/O	Connect to crystal oscillator input
29	VDDD	Р	Analog Power 2.5 V ~ 3.6 V
30	VDDA	Р	Analog Power 2.5 V ~ 3.6 V

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2. Pin Definitions

Pin	Name	Туре	Function		
31	RES12K	I	Serial connection with a 12 $k\Omega$ resistor and connect to the ground		
32	EXT_RSTB	I	External reset signal (Low voltage level: active)		

- GPIO2, GPIO0, and MTDO are used to select booting mode and the SDIO mode;
   U0TXD should not be pulled externally to a low logic level during the powering-up.



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3. Functional Description



## **Functional Description**

The functional diagram of ESP8266EX is shown as in Figure 3-1.

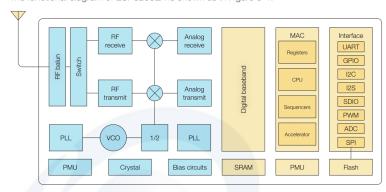


Figure 3-1. Functional Block Diagram

#### 3.1. CPU, Memory, and Flash

#### 3.1.1. CPU

The ESP8266EX integrates a Tensilica L106 32-bit RISC processor, which achieves extralow power consumption and reaches a maximum clock speed of 160 MHz. The Real-Time Operating System (RTOS) and Wi-Fi stack allow 80% of the processing power to be available for user application programming and development. The CPU includes the interfaces as below:

- Programmable RAM/ROM interfaces (iBus), which can be connected with memory controller, and can also be used to visit flash.
- Data RAM interface (dBus), which can connected with memory controller.
- AHB interface which can be used to visit the register.

#### 3.1.2. Memory

ESP8266EX Wi-Fi SoC integrates memory controller and memory units including SRAM and ROM. MCU can access the memory units through iBus, dBus, and AHB interfaces. All memory units can be accessed upon request, while a memory arbiter will decide the running sequence according to the time when these requests are received by the processor.

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3. Functional Description

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According to our current version of SDK, SRAM space available to users is assigned as below

- RAM size < 50 kB, that is, when ESP8266EX is working under the Station mode and connects to the router, the maximum programmable space accessible in Heap + Data section is around 50 kB.
- There is no programmable ROM in the SoC. Therefore, user program must be stored in an external SPI flash.

#### 3.1.3. External Flash

 $\mbox{ESP8266EX}$  uses external SPI flash to store user programs, and supports up to 16 MB memory capacity theoretically.

The minimum flash memory of ESP8266EX is shown below:

- OTA disabled: 512 kB at least
- · OTA enabled: 1 MB at least

#### Notice

SPI mode supported: Standard SPI, Dual SPI and Quad SPI. The correct SPI mode should be selected when flashing bin files to ESP8266. Otherwise, the downloaded firmware/program may not be working properly.

#### 3.2. Clock

#### 3.2.1. High Frequency Clock

The high frequency clock on ESP8266EX is used to drive both transmit and receive mixers. This clock is generated from internal crystal oscillator and external crystal. The crystal frequency ranges from 24 MHz to 52 MHz.

The internal calibration inside the crystal oscillator ensures that a wide range of crystals can be used, nevertheless the quality of the crystal is still a factor to consider to have reasonable phase noise and good Wi-Fi sensitivity. Refer to Table 3-1 to measure the frequency offset.

Table 3-1. High Frequency Clock Specifications

Parameter	Symbol	Min	Max	Unit
Frequency	FXO	24	52	MHz
Loading capacitance	CL	-	32	pF
Motional capacitance	CM	2	5	pF
Series resistance	RS	0	65	Ω

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3. Functional Description



Parameter	Symbol	Min	Max	Unit
Frequency tolerance	ΔΕΧΟ	-15	15	ppm
Frequency vs temperature (-25 °C ~ 75 °C)	ΔFXO,Temp	-15	15	ppm

#### 3.2.2. External Clock Requirements

An externally generated clock is available with the frequency ranging from 24 MHz to 52 MHz. The following characteristics are expected to achieve good performance of radio.

Table 3-2. External Clock Reference

Parameter	Symbol	Min	Max	Unit
Clock amplitude	VXO	0.8	1.5	Vpp
External clock accuracy	ΔFXO,EXT	-15	15	ppm
Phase noise @1-kHz offset, 40-MHz clock		-	-120	dBc/Hz
Phase noise @10-kHz offset, 40-MHz clock	-	-	-130	dBc/Hz
Phase noise @100-kHz offset, 40-MHz clock	-	-	-138	dBc/Hz

#### 3.3. Radio

ESP8266EX radio consists of the following blocks.

- 2.4 GHz receiver
- 2.4 GHz transmitter
- High speed clock generators and crystal oscillator
- Bias and regulators
- Power management

#### 3.3.1. Channel Frequencies

The RF transceiver supports the following channels according to IEEE802.11 b/g/n standards

Table 3-3. Frequency Channel

Channel No.	Frequency (MHz)	Channel No.	Frequency (MHz)
1	2412	8	2447
2	2417	9	2452
3	2422	10	2457
4	2427	11	2462

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3. Functional Description

Channel No.	Frequency (MHz)	Channel No.	Frequency (MHz)
5	2432	12	2467
6	2437	13	2472
7	2442	14	2484

#### 3.3.2. 2.4 GHz Receiver

The 2.4 GHz receiver down-converts the RF signals to quadrature baseband signals and converts them to the digital domain with 2 high resolution high speed ADCs. To adapt to varying signal channel conditions, RF filters, automatic gain control (AGC), DC offset cancelation circuits and baseband filters are integrated within ESP8266EX.

#### 3.3.3. 2.4 GHz Transmitter

The 2.4 GHz transmitter up-converts the quadrature baseband signals to 2.4 GHz, and drives the antenna with a high-power CMOS power amplifier. The function of digital calibration further improves the linearity of the power amplifier, enabling a state of art performance of delivering +19.5 dBm average TX power for 802.11b transmission and +18 dBm for 802.11n (MSC0) transmission.

Additional calibrations are integrated to offset any imperfections of the radio, such as:

- Carrier leakage
- I/Q phase matching
- Baseband nonlinearities

These built-in calibration functions reduce the product test time and make the test equipment unnecessary.

#### 3.3.4. Clock Generator

The clock generator generates quadrature 2.4 GHz clock signals for the receiver and transmitter. All components of the clock generator are integrated on the chip, including all inductors, varactors, loop filters, linear voltage regulators and dividers.

The clock generator has built-in calibration and self test circuits. Quadrature clock phases and phase noise are optimized on-chip with patented calibration algorithms to ensure the best performance of the receiver and transmitter.

#### 3.4. Wi-Fi

ESP8266EX implements TCP/IP and full 802.11 b/g/n WLAN MAC protocol. It supports Basic Service Set (BSS) STA and SoftAP operations under the Distributed Control Function (DCF). Power management is handled with minimum host interaction to minimize active-duty period.

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3. Functional Description



#### 3.4.1. Wi-Fi Radio and Baseband

The ESP8266EX Wi-Fi Radio and Baseband support the following features:

- 802.11 b and 802.11 g
- 802.11 n MCS0-7 in 20 MHz bandwidth
- 802.11 n 0.4 µs guard-interval
- up to 72.2 Mbps of data rate
- Receiving STBC 2 x 1
- Up to 20.5 dBm of transmitting power
- Adjustable transmitting power

#### 3.4.2. Wi-Fi MAC

The ESP8266EX Wi-Fi MAC applies low-level protocol functions automatically, as follows:

- 2 × virtual Wi-Fi interfaces
- Infrastructure BSS Station mode/SoftAP mode/Promiscuous mode
- Request To Send (RTS), Clear To Send (CTS) and Immediate Block ACK
- Defragmentation
- CCMP (CBC-MAC, counter mode), TKIP (MIC, RC4), WEP (RC4) and CRC
- Automatic beacon monitoring (hardware TSF)
- Dual and single antenna Bluetooth co-existence support with optional simultaneous receive (Wi-Fi/Bluetooth) capability

#### 3.5. Power Management

ESP8266EX is designed with advanced power management technologies and intended for mobile devices, wearable electronics and the Internet of Things applications.

The low-power architecture operates in the following modes:

- Active mode: The chip radio is powered on. The chip can receive, transmit, or listen.
- Modem-sleep mode: The CPU is operational. The Wi-Fi and radio are disabled.
- Light-sleep mode: The CPU and all peripherals are paused. Any wake-up events (MAC, host, RTC timer, or external interrupts) will wake up the chip.
- Deep-sleep mode: Only the RTC is operational and all other part of the chip are powered off.

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3. Functional Description



Table 3-4. Power Consumption by Power Modes

Power Mode	Description	Power Consumption
Anti-or (DE condino)	Wi-Fi TX packet	Disease refer to Table 5.0
Active (RF working)	Wi-Fi RX packet	Please refer to Table 5-2.
Modem-sleep <sup>⊕</sup>	CPU is working	15 mA
Light-sleep <sup>②</sup>	-	0.9 mA
Deep-sleep <sup>®</sup>	Only RTC is working	20 uA
Shut down	-	0.5 uA

#### Notes:

- Modem-sleep mode is used in the applications that require the CPU to be working, as in PWM or I2S applications. According to 802.11 standards (like U-APSD), it shuts down the Wi-Fi Modem circuit while maintaining a Wi-Fi connection with no data transmission to optimize power consumption. E.g., in DTIM3, maintaining a sleep of 300 ms with a wakeup of 3 ms cycle to receive AP's Beacon packages at interval requires about 15 mA current.
- ② During Light-sleep mode, the CPU may be suspended in applications like Wi-Fi switch. Without data transmission, the Wi-Fi Modern circuit can be turned off and CPU suspended to save power consumption according to the 802.11 standards (U-APSD). E.g. in DTIM3, maintaining a sleep of 300 ms with a wakeup of 3ms to receive AP's Beacon packages at interval requires about 0.9 mA current.
- 3 During Deep-sleep mode, Wi-Fi is turned off. For applications with long time lags between data transmission, e.g. a temperature sensor that detects the temperature every 100 s, sleeps for 300 s and wakes up to connect to the AP (taking about 0.3 ~ 1 s), the overall average current is less than 1 mA. The current of 20 µA is acquired at the voltage of 2.5 V.

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4. Peripheral Interface

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#### 4.

## Peripheral Interface

#### 4.1. General Purpose Input/Output Interface (GPIO)

ESP8266EX has 17 GPIO pins which can be assigned to various functions by programming the appropriate registers.

Each GPIO PAD can be configured with internal pull-up or pull-down (XPD\_DCDC can only be configured with internal pull-down, other GPIO PAD can only be configured with internal pull-up), or set to high impedance. When configured as an input, the data are stored in software registers; the input can also be set to edge-trigger or level trigger CPU interrupts. In short, the IO pads are bi-directional, non-inverting and tristate, which includes input and output buffer with tristate control inputs.

These pins, when working as GPIOs, can be multiplexed with other functions such as I2C, I2S, UART, PWM, and IR Remote Control, etc.

#### 4.2. Secure Digital Input/Output Interface (SDIO)

ESP8266EX has one Slave SDIO, the definitions of which are described as Table 4-1, which supports 25 MHz SDIO v1.1 and 50 MHz SDIO v2.0, and 1 bit/4 bit SD mode and SPI mode.

Table 4-1. Pin Definitions of SDIOs

Pin Name	Pin Num	10	Function Name
SDIO_CLK	21	106	SDIO_CLK
SDIO_DATA0	22	107	SDIO_DATA0
SDIO_DATA1	23	108	SDIO_DATA1
SDIO_DATA_2	18	109	SDIO_DATA_2
SDIO_DATA_3	19	IO10	SDIO_DATA_3
SDIO_CMD	20	IO11	SDIO_CMD

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4. Peripheral Interface

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#### 4.3. Serial Peripheral Interface (SPI/HSPI)

ESP8266EX has two SPIs.

- One general Slave/Master SPI
- One general Slave/Master HSPI

Functions of all these pins can be implemented via hardware.

#### 4.3.1. General SPI (Master/Slave)

Table 4-2. Pin Definitions of SPIs

Pin Name	Pin Num	10	Function Name
SDIO_CLK	21	106	SPICLK
SDIO_DATA0	22	107	SPIQ/MISO
SDIO_DATA1	23	108	SPID/MOSI
SDIO_DATA_2	18	109	SPIHD
SDIO_DATA_3	19	IO10	SPIWP
UOTXD	26	IO1	SPICS1
GPI00	15	100	SPICS2
SDIO_CMD	20	IO11	SPICS0

Note:

SPI mode can be implemented via software programming. The clock frequency is 80 MHz at maximum when working as a master, 20 MHz at maximum when working as a slave.

#### 4.3.2. HSPI (Master/Slave)

Table 4-3. Pin Definitions of HSPI

Pin Name	Pin Num	10	Function Name
MTMS	9	IO14	HSPICLK
MTDI	10	IO12	HSPIQ/MISO
MTCK	12	IO13	HSPID/MOSI
MTDO	13	IO15	HPSICS
Note:			

□ Note

SPI mode can be implemented via software programming. The clock frequency is 20 MHz at maximum.

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4. Peripheral Interface

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#### 4.4. I2C Interface

ESP8266EX has one I2C, which is realized via software programming, used to connect with other microcontrollers and other peripheral equipments such as sensors. The pin definition of I2C is as below.

Table 4-4. Pin Definitions of I2C

Pin Name	Pin Num	Ю	Function Name
MTMS	9	IO14	I2C_SCL
GPIO2	14	102	I2C_SDA

Both I2C Master and I2C Slave are supported. I2C interface functionality can be realized via software programming, and the clock frequency is 100 kHz at maximum.

#### 4.5. I2S Interface

ESP8266EX has one I2S data input interface and one I2S data output interface, and supports the linked list DMA. I2S interfaces are mainly used in applications such as data collection, processing, and transmission of audio data, as well as the input and output of serial data. For example, LED lights (WS2812 series) are supported. The pin definition of I2S is shown in Table 4-5.

Table 4-5. Pin Definitions of I2S

I2S Data Input			
Pin Name	Pin Num	Ю	Function Name
MTDI	10	IO12	I2SI_DATA
MTCK	12	IO13	I2SI_BCK
MTMS	9	IO14	I2SI_WS
MTDO	13	IO15	I2SO_BCK
UORXD	25	IO3	I2SO_DATA
GPIO2	14	102	I2SO_WS

#### 4.6. Universal Asynchronous Receiver Transmitter (UART)

 $\ensuremath{\mathsf{ESP8266EX}}$  has two UART interfaces UART0 and UART1, the definitions are shown in Table 4-6.

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4. Peripheral Interface



Table 4-6. Pin Definitions of UART

Pin Type	Pin Name	Pin Num	Ю	Function Name
	U0RXD	25	IO3	U0RXD
UARTO	U0TXD	26	IO1	U0TXD
UARTU	MTDO	13	IO15	U0RTS
	MTCK	12	IO13	U0CTS
UART1	GPIO2	14	102	U1TXD
	SD_D1	23	108	U1RXD

Data transfers to/from UART interfaces can be implemented via hardware. The data transmission speed via UART interfaces reaches 115200 x 40 (4.5 Mbps).

UARTO can be used for communication. It supports flow control. Since UART1 features only data transmit signal (TX), it is usually used for printing log.

By default, UARTO outputs some printed information when the device is powered on and booting up. The baud rate of the printed information is relevant to the frequency of the external crystal oscillator. If the frequency of the crystal oscillator is 40 MHz, then the baud rate for printing is 115200; if the frequency of the crystal oscillator is 26 MHz, then the baud rate for printing is 74880. If the printed information exerts any influence on the functionality of the device, it is suggested to block the printing during the power-on period by changing (U0TXD, U0RXD) to (MTDO, MTCK).

#### 4.7. Pulse-Width Modulation (PWM)

ESP8266EX has four PWM output interfaces. They can be extended by users themselves. The pin definitions of the PWM interfaces are defined as below.

Table 4-7. Pin Definitions of PWM

Pin Name	Pin Num	10	Function Name
MTDI	10	IO12	PWM0
MTDO	13	IO15	PWM1
MTMS	9	IO14	PWM2
GPIO4	16	IO4	PWM3

The functionality of PWM interfaces can be implemented via software programming. For example, in the LED smart light demo, the function of PWM is realized by interruption of the timer, the minimum resolution reaches as high as 44 ns. PWM frequency range is adjustable from 1000  $\mu s$  to 10000  $\mu s$ , i.e., between 100 Hz and 1 kHz. When the PWM

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4. Peripheral Interface

frequency is 1 kHz, the duty ratio will be 1/22727, and a resolution of over 14 bits will be achieved at 1 kHz refresh rate.

#### 4.8. IR Remote Control

ESP8266EX currently supports one infrared remote control interface. For detailed pin definitions, please see Table 4-8 below.

Table 4-8. Pin Definitions of IR Remote Control

Pin Name	Pin Num	Ю	Function Name
MTMS	9	IO14	IR TX
GPIO5	24	IO 5	IR Rx

The functionality of Infrared remote control interface can be implemented via software programming. NEC coding, modulation, and demodulation are supported by this interface. The frequency of modulated carrier signal is 38 kHz, while the duty ratio of the square wave is 1/3. The transmission range is around 1m which is determined by two factors: one is the maximum current drive output, the other is internal current-limiting resistance value in the infrared receiver. The larger the resistance value, the lower the current, so is the power, and vice versa.

#### 4.9. ADC (Analog-to-Digital Converter)

ESP8266EX is embedded with a 10-bit precision SAR ADC. TOUT (Pin6) is defined as below:

Table 4-9. Pin Definition of ADC

Pin Name	Pin Num	Function Name
TOUT	6	ADC Interface

The following two measurements can be implemented using ADC (Pin6). However, they cannot be implemented at the same time.

• Measure the power supply voltage of VDD3P3 (Pin3 and Pin4).

Hardware Design	TOUT must be floating.	
RF Initialization Parameter	The 107th byte of $esp\_init\_data\_default.bin$ (0 ~ 127 bytes), vdd33_const must be set to $@xFF$ .	
RF Calibration Process	Optimize the RF circuit conditions based on the testing results of VDD3P3 (Pin3 and Pin4).	
User Programming	Use system_get_vdd33 instead of system_adc_read.	

• Measure the input voltage of TOUT (Pin6).

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4. Peripheral Interface

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Hardware Design	The input voltage range is 0 to 1.0 V when TOUT is connected to external circuit.
RF Initialization Parameter	The value of the 107th byte of esp_init_data_default.bin (0 ~ 127 bytes), vdd33_const must be set to the real power supply voltage of Pin3 and Pin4. The unit and effective value range of vdd33_const is 0.1 V and 18 to 36, respectively, thus making the working power voltage range of ESP8266EX between 1.8 V and 3.6 V.
RF Calibration Process	Optimize the RF circuit conditions based on the value of vdd33_const. The permissible error is $\pm0.2$ V.
User Programming	Use system_adc_read instead of system_get_vdd33.

#### Notes:

esp\_init\_data\_default.bin is provided in SDK package which contains RF initialization parameters (0 ~ 127 bytes). The name of the 107th byte in esp\_init\_data\_default.bin is vdd33\_const, which is defined as below:

- When vdd33\_const = 0xff, the power voltage of Pin3 and Pin4 will be tested by the internal selfcalibration process of ESP8266EX itself. RF circuit conditions should be optimized according to the testing results.
- When 18 = < vdd33\_const = < 36, ESP8266EX RF Callibration and optimization process is implemented via (vdd33\_const/10).
- When vdd33\_const < 18 or 36 < vdd33\_const < 255, vdd33\_const is invalid. ESP8266EX RF Calibration and optimization process is implemented via the default value 3.3 V.

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5. Electrical Specifications



## 5. Electrical Specifications

#### 5.1. Electrical Characteristics

Table 5-1. Electrical Characteristics

Parameters		Conditions	Min	Typical	Max	Unit
Operating Temperature Range		-	-40	Normal	125	°C
Maximum Soldering Temperature		IPC/JEDEC J- STD-020	-	-	260	°C
Working Voltage Value			2.5	3.3	3.6	V
l/O	V <sub>IL</sub>	-	-0.3	-	0.25 V <sub>IO</sub>	
	$V_{\text{IH}}$		0.75 V <sub>IO</sub>		3.6	
	V <sub>OL</sub>	-	-	-	0.1 V <sub>IO</sub>	
	V <sub>OH</sub>		0.8 V <sub>IO</sub>		-	
	IMAX	-	-	-	12	mA
Electrostatic Discharge (HBM)		TAMB = 25 °C	-	- /	2	KV
Electrostatic Discharge (CDM)		TAMB = 25 °C	-	-	0.5	KV

#### Notes on CHIP\_EN:

The figure below shows ESP8266EX power-up and reset timing. Details about the parameters are listed in Table 5-2.

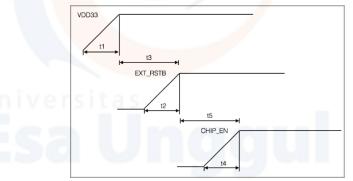


Figure 5-1. ESP8266EX Power-up and Reset Timing

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5. Electrical Specifications



Table 5-2. Description of ESP8266EX Power-up and Reset Timing Parameters

	Description		Max	Unit
t1	The rise-time of VDD33	10	2000	μs
t2	The rise-time of EXT_RSTB	0	2	ms
t3	EXT_RSTB goes high after VDD33	0.1	-	ms
t4	The rise-time of CHIP_EN	0	2	ms
t5	CHIP_EN goes high after EXT_RSTB	0.1	-	ms

#### 5.2. RF Power Consumption

Unless otherwise specified, the power consumption measurements are taken with a 3.0 V supply at 25  $^{\circ}$ C of ambient temperature. All transmitters' measurements are based on a 50% duty cycle.

Table 5-3. Power Consumption

Parameters	Min	Typical	Max	Unit
TX802.11 b, CCK 11 Mbps, Pout = +17 dBm	-	170	-	mA
TX802.11 g, OFDM 54Mbps, Pout = +15 dBm	/-/	140	-	mA
TX802.11 n, MCS7, P <sub>OUT</sub> = +13 dBm	-	120	-	mA
Rx802.11 b, 1024 bytes packet length, -80 dBm	-	50	-	mA
Rx802.11 g, 1024 bytes packet length, -70 dBm	-	56	-	mA
Rx802.11 n, 1024 bytes packet length, -65 dBm	-	56	-	mA

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5. Electrical Specifications



#### 5.3. Wi-Fi Radio Characteristics

The following data are from tests conducted at room temperature, with a 3.3  $\mbox{\rm V}$  power supply.

Table 5-3. Wi-Fi Radio Characteristics

Parameters	Min	Typical	Max	Unit		
Input frequency	2412	-	2484	MHz		
Output impedance	-	39 + j6	-	Ω		
Output power of PA for 72.2 Mbps	15.5	16.5	17.5	dBm		
Output power of PA for 11b mode	19.5	20.5	21.5	dBm		
Sensitivity						
DSSS, 1 Mbps	-	-98	-	dBm		
CCK, 11 Mbps	-	-91	-	dBm		
6 Mbps (1/2 BPSK)	-	-93	-	dBm		
54 Mbps (3/4 64-QAM)	-	-75	-	dBm		
HT20, MCS7 (65 Mbps, 72.2 Mbps)	-	-72	-	dBm		
Adjacent Channel Rejection						
OFDM, 6 Mbps	-	37	-	dB		
OFDM, 54 Mbps	-	21	-	dB		
HT20, MCS0	-	37	-	dB		
HT20, MCS7	- /	20	-	dB		

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6.

## Package Information

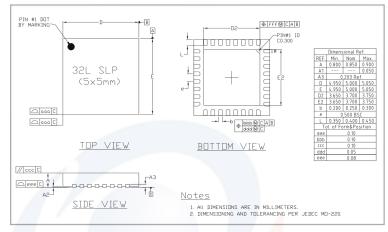


Figure 6-1. ESP8266EX Package

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Appendix I



### Appendix - Pin List

For detailed pin information, please see **ESP8266 Pin List**.

- Digital Die Pin List
- Buffer Sheet
- Register List
- Strapping List

- INST\_NAME refers to the IO\_MUX REGISTER defined in <code>eagle\_soc.h</code>, for example MTDI\_U refers to PERIPHS\_IO\_MUX\_MTDI\_U.
- Net Name refers to the pin name in schematic.
- Function refers to the multifunction of each pin pad.
- $\bullet~$  Function number 1  $\sim$  5 correspond to FUNCTION 0  $\sim$  4 in SDK. For example, set MTDI to GPIO12 as

  - #define FUNC\_GPI012 3 //defined in eagle\_soc.h
    PIN\_FUNC\_SELECT(PERIPHS\_IO\_MUX\_MTDI\_U,FUNC\_GPI012)

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Appendix II



#### II.

# Appendix - Learning Resources

#### II.1. Must-Read Documents

• ESP8266 Quick Start Guide

Description: This document is a quick user guide to getting started with ESP8266. It includes an introduction to the ESP-LAUNCHER, instructions on how to download firmware to the board and run it, how to compile the AT application, as well as the structure and debugging method of RTOS SDK. Basic documentation and other related resources for the ESP8266 are also provided.

• ESP8266 SDK Getting Started Guide

Description: This document takes ESP-LAUNCHER and ESP-WROOM-02 as examples of how to use the ESP8266 SDK. The contents include preparations before compilation, SDK compilation and firmware download.

ESP8266 Pin List

Description: This link directs you to a list containing the type and function of every ESP8266 pin.

• ESP8266 Hardware Design Guideline

Description: This document provides a technical description of the ESP8266 series of products, including ESP8266EX, ESP-LAUNCHER and ESP-WROOM.

• ESP8266 Technical Reference

Description: This document provides an introduction to the interfaces integrated on ESP8266. Functional overview, parameter configuration, function description, application demos and other pieces of information are included.

• ESP8266 Hardware Resources

Description: This zip package includes manufacturing BOMs, schematics and PCB layouts of ESP8266 boards and modules.

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#### II.2. Must-Have Resources

• ESP8266 SDKs

Description: This webpage provides links both to the latest version of the ESP8266 SDK and the older ones.

• ESP8266 Tools

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Description: This webpage provides links to both the ESP8266 flash download tools and the ESP8266 performance evaluation tools.

- ESP8266 Apps
- ESP8266 Certification and Test Guide
- ESP8266 BBS
- ESP8266 Resources



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Lampiran 3 Data Sheet DHT 11

# DHT11 Humidity & Temperature Sensor

DHT11 Temperature & Humidity Sensor features a temperature & humidity sensor complex with a calibrated digital signal output.

# DHT 11 Humidity & Temperature

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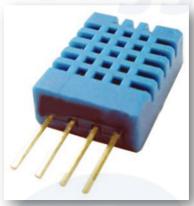
#### 1. Introduction

Sensor

DHT11 Temperature & Humidity Sensor features a temperature & humidity sensor complex with a calibrated digital signal output. By using the exclusive digital-signal-acquisition technique and temperature & humidity sensing technology, it ensures high reliability and excellent long-term stability. This sensor includes a resistive-type humidity measurement component and an NTC temperature measurement component, and connects to a high-performance 8-bit microcontroller, offering excellent quality, fast response, anti-interference ability and cost-effectiveness.

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Each DHT11 element is strictly calibrated in the laboratory that is extremely accurate on humidity calibration. The calibration coefficients are stored as programmes in the OTP memory, which are used by the sensor's internal signal detecting process. The single-wire serial interface makes system integration quick and easy. Its small size, low power consumption and up-to-20 meter signal transmission making it the best choice for various applications, including those most demanding ones. The component is 4-pin single row pin package. It is convenient to connect and special packages can be provided according to users' request.

#### 2. Technical Specifications:

#### Overview:

Item	Measurement	Humidity	Temperature	Resolution	Package
	Range	Accuracy	Accuracy		
DHT11	20-90%RH	±5%RH	±2°C	1	4 Pin Single
	0-50 ℃				Row



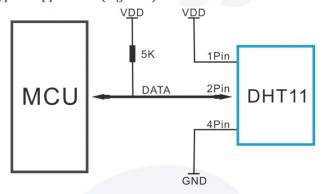
# Detailed Specifications:

Parameters	Conditions	Minimum	Typical	Maximum		
Humidity						
Resolution		1%RH	1%RH	1%RH		
			8 Bit			
Repeatability			$\pm$ 1%RH			
Accuracy	25℃		±4%RH			
	0-50℃			±5%RH		
Interchangeability	Fully Interchange	Fully Interchangeable				
Measurement	0℃	30%RH		90%RH		
Range	25℃	20%RH		90%RH		
	50℃	20%RH		80%RH		
Response Time	1/e(63%)25℃,	6 S	10 S	15 S		
(Seconds)	1m/s Air					
Hysteresis			±1%RH			
Long-Term Stability	Typical		$\pm$ 1%RH/year			
Temperature						
Resolution		1℃	1°C	1°C		
		8 Bit	8 Bit	8 Bit		
Repeatability			±1°C			
Accuracy		±1℃		±2℃		
Measurement Range		0℃		50°C		
Response Time (Seconds)	1/e(63%)	6 S		30 S		

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#### 3. Typical Application (Figure 1)



**Figure 1 Typical Application** 

Note: 3Pin - Null; MCU = Micro-computer Unite or single chip Computer

When the connecting cable is shorter than 20 metres, a 5K pull-up resistor is recommended; when the connecting cable is longer than 20 metres, choose a appropriate pull-up resistor as needed.

#### 4. Power and Pin

DHT11's power supply is 3-5.5V DC. When power is supplied to the sensor, do not send any instruction to the sensor in within one second in order to pass the unstable status. One capacitor valued 100nF can be added between VDD and GND for power filtering.

#### 5. Communication Process: Serial Interface (Single-Wire Two-Way)

Single-bus data format is used for communication and synchronization between MCU and DHT11 sensor. One communication process is about 4ms.

Data consists of decimal and integral parts. A complete data transmission is 40bit, and the sensor sends higher data bit first.

Data format: 8bit integral RH data + 8bit decimal RH data + 8bit integral T data + 8bit decimal T data + 8bit check sum. If the data transmission is right, the check-sum should be the last 8bit of "8bit integral RH data + 8bit decimal RH data + 8bit integral T data + 8bit decimal T data".



# 5.1 Overall Communication Process (Figure 2, below)

When MCU sends a start signal, DHT11 changes from the low-power-consumption mode to the running-mode, waiting for MCU completing the start signal. Once it is completed, DHT11 sends a response signal of 40-bit data that include the relative humidity and temperature information to MCU. Users can choose to collect (read) some data. Without the start signal from MCU, DHT11 will not give the response signal to MCU. Once data is collected, DHT11 will change to the low-power-consumption mode until it receives a start signal from MCU again.

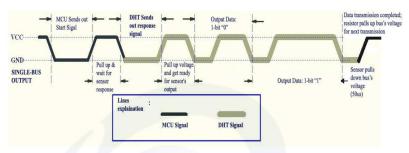


Figure 2 Overall Communication Process

#### 5.2 MCU Sends out Start Signal to DHT (Figure 3, below)

Data Single-bus free status is at high voltage level. When the communication between MCU and DHT11 begins, the programme of MCU will set Data Single-bus voltage level from high to low and this process must take at least 18ms to ensure DHT's detection of MCU's signal, then MCU will pull up voltage and wait 20-40us for DHT's response.

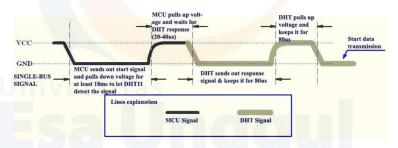


Figure 3 MCU Sends out Start Signal & DHT Responses

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# 5.3 DHT Responses to MCU (Figure 3, above)

Once DHT detects the start signal, it will send out a low-voltage-level response signal, which lasts 80us. Then the programme of DHT sets Data Single-bus voltage level from low to high and keeps it for 80us for DHT's preparation for sending data.

When DATA Single-Bus is at the low voltage level, this means that DHT is sending the response signal. Once DHT sent out the response signal, it pulls up voltage and keeps it for 80us and prepares for data transmission.

When DHT is sending data to MCU, every bit of data begins with the 50us low-voltage-level and the length of the following high-voltage-level signal determines whether data bit is "0" or "1" (see Figures 4 and 5 below).

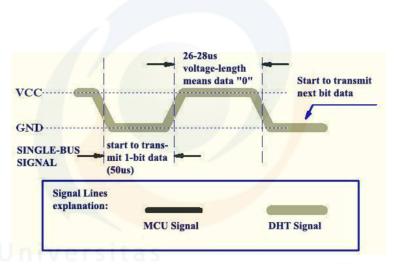


Figure 4 Data "0" Indication

# VCC Start to transmit next bit data "1" Start to transmit next bit data GND Start to transmit 1-bit data (Sous) Signal Lines Explanation: MCU Signal DHT Signal

Figure 5 Data "1" Indication

If the response signal from DHT is always at high-voltage-level, it suggests that DHT is not responding properly and please check the connection. When the last bit data is transmitted, DHT11 pulls down the voltage level and keeps it for 50us. Then the Single-Bus voltage will be pulled up by the resistor to set it back to the free status.

#### 6. Electrical Characteristics

VDD=5V, T =  $25^{\circ}$ C (unless otherwise stated)

	Conditions	Minimum	Typical	Maximum
Power Supply	DC	3V	5V	5.5V
Current	Measuring	0.5mA		2.5mA
Supply				
	Average	0.2mA		1mA
	Standby	100uA		150uA
Sampling period	Second	1		

Note: Sampling period at intervals should be no less than 1 second.

#### 7. Attentions of application

#### (1) Operating conditions

Applying the DHT11 sensor beyond its working range stated in this datasheet can result in 3%RH signal shift/discrepancy. The DHT11 sensor can recover to the calibrated status gradually when it gets back to the normal operating condition and works within its range. Please refer to (3) of

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this section to accelerate its recovery. Please be aware that operating the DHT11 sensor in the non-normal working conditions will accelerate sensor's aging process.

#### (2) Attention to chemical materials

Vapor from chemical materials may interfere with DHT's sensitive-elements and debase its sensitivity. A high degree of chemical contamination can permanently damage the sensor.

#### (3) Restoration process when (1) & (2) happen

Step one: Keep the DHT sensor at the condition of Temperature  $50^{\sim}60$ Celsius, humidity <10%RH for 2 hours;

Step two:K keep the DHT sensor at the condition of Temperature 20~30Celsius, humidity >70%RH for 5 hours.

#### (4) Temperature Affect

Relative humidity largely depends on temperature. Although temperature compensation technology is used to ensure accurate measurement of RH, it is still strongly advised to keep the humidity and temperature sensors working under the same temperature. DHT11 should be mounted at the place as far as possible from parts that may generate heat.

#### (5) Light Affect

Long time exposure to strong sunlight and ultraviolet may debase  $\operatorname{DHT}\nolimits'\!\operatorname{s}$  performance.

#### (6) Connection wires

The quality of connection wires will affect the quality and distance of communication and high quality shielding-wire is recommended.

#### (7) Other attentions

- \* Welding temperature should be bellow 260Celsius and contact should take less than 10 seconds.
- \* Avoid using the sensor under dew condition.
- \* Do not use this product in safety or emergency stop devices or any other occasion that failure of DHT11 may cause personal injury.
- \* Storage: Keep the sensor at temperature 10-40°C, humidity <60%RH.

#### Disclaimer

This is a translated version of the manufacturer's data sheet. OSEPP is not responsible for the accuracy of the translated information.

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#### Lampiran 4 NodeMCU Base-board



## **Handson Technology**

**User Guide** 

#### ESP8266 NodeMCU I/O Expansion Board

This base board is the Breakout Board for ESP8266 NodeMcu V3 Lua CH340 WiFi Development Board. All the I/O ports are easily accessible thru the 2.54mm pin header for easy prototyping. This baseboard also with on board 5V regulator. Accept power input of 5~12V thru 5.5mm power from wall plug adapter. The perfect solution for breaking out the pins from Lua V3 Nodemcu.





**SKU: MDU1076** 

#### **Brief Data:**

- Small and handy module.
- Supply Voltage: 6~24Vdc.
- The spacing between headers pin: 2.54 mm.
- Lead-out all the I/O ports of the ESP-12E development board.
- Lead out the pins of 5V and 3.3V power supply.
- Convenient to connect with peripheral modules with jumper wires.
- Onboard 5V/1A DC-DC step-down converter circuit.
- Onboard power-on LED indicator.
- Board Dimension: 60x60 mm.

www.handsontec.com

**Base-board** 

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